

## FDN372S

### 30V N-Channel PowerTrench® SyncFET™

#### General Description

The FDN372S is designed to replace a single MOSFET and Schottky diode, used in synchronous DC-DC power supplies, with a single integrated component. This 30V MOSFET is designed to maximize power conversion efficiency with low  $R_{DS(ON)}$  and low gate charge. The FDN372S includes an integrated Schottky diode using Fairchild Semiconductor's monolithic SyncFET process, making it ideal as the low side switch in a synchronous converter.

#### Applications

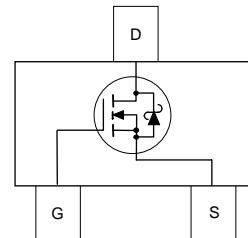
- DC-DC Converter
- Motor Drives

#### Features

- 2.6 A, 30 V.  $R_{DS(ON)} = 40 \text{ m}\Omega @ V_{GS} = 10 \text{ V}$   
 $R_{DS(ON)} = 50 \text{ m}\Omega @ V_{GS} = 4.5 \text{ V}$
- Low gate charge
- Fast switching speed
- High performance trench technology for extremely low  $R_{DS(ON)}$



SuperSOT™-3



#### Absolute Maximum Ratings

$T_A=25^\circ\text{C}$  unless otherwise noted

Symbol	Parameter	Ratings	Units
$V_{DSS}$	Drain-Source Voltage	30	V
$V_{GSS}$	Gate-Source Voltage	$\pm 16$	V
$I_D$	Drain Current – Continuous – Pulsed	2.6 10	A
	(Note 1a)		
$P_D$	Power Dissipation for Single Operation (Note 1a) (Note 1b)	0.5 0.46	W
$T_J, T_{STG}$	Operating and Storage Junction Temperature Range	-55 to +150	°C

#### Thermal Characteristics

$R_{\theta JA}$	Thermal Resistance, Junction-to-Ambient (Note 1a)	250	°C/W
$R_{\theta JC}$	Thermal Resistance, Junction-to-Case (Note 1)	75	°C/W

#### Package Marking and Ordering Information

Device Marking	Device	Reel Size	Tape width	Quantity
372	FDN372S	7"	8mm	3000 units

## Electrical Characteristics

$T_A = 25^\circ\text{C}$  unless otherwise noted

Symbol	Parameter	Test Conditions	Min	Typ	Max	Units
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### Off Characteristics

$\text{BV}_{\text{DSS}}$	Drain–Source Breakdown Voltage	$V_{\text{GS}} = 0 \text{ V}$ , $I_D = 1 \text{ mA}$	30			V
$\Delta \text{BV}_{\text{DSS}}$ $\Delta T_J$	Breakdown Voltage Temperature Coefficient	$I_D = 10 \text{ mA}$ , Referenced to $25^\circ\text{C}$		24		$\text{mV}/^\circ\text{C}$
$I_{\text{DSS}}$	Zero Gate Voltage Drain Current	$V_{\text{DS}} = 24 \text{ V}$ , $V_{\text{GS}} = 0 \text{ V}$			500	$\mu\text{A}$
$I_{\text{GSS}}$	Gate–Body Leakage	$V_{\text{GS}} = \pm 16 \text{ V}$ , $V_{\text{DS}} = 0 \text{ V}$			$\pm 100$	nA

### On Characteristics (Note 2)

$V_{\text{GS}(\text{th})}$	Gate Threshold Voltage	$V_{\text{DS}} = V_{\text{GS}}$ , $I_D = 1 \text{ mA}$	1	1.4	3	V
$\Delta V_{\text{GS}(\text{th})}$ $\Delta T_J$	Gate Threshold Voltage Temperature Coefficient	$I_D = 10 \text{ mA}$ , Referenced to $25^\circ\text{C}$		-3.2		$\text{mV}/^\circ\text{C}$
$R_{\text{DS}(\text{on})}$	Static Drain–Source On–Resistance	$V_{\text{GS}} = 10 \text{ V}$ , $I_D = 2.6 \text{ A}$ $V_{\text{GS}} = 4.5 \text{ V}$ , $I_D = 2.3 \text{ A}$ $V_{\text{GS}} = 10 \text{ V}$ , $I_D = 2.6 \text{ A}$ , $T_J = 125^\circ\text{C}$	32 36 45	40 50 60		$\text{m}\Omega$
$I_{\text{D}(\text{on})}$	On–State Drain Current	$V_{\text{GS}} = 10 \text{ V}$ , $V_{\text{DS}} = 5 \text{ V}$	10			A
$g_{\text{FS}}$	Forward Transconductance	$V_{\text{DS}} = 10 \text{ V}$ , $I_D = 2.6 \text{ A}$		15		S

### Dynamic Characteristics

$C_{\text{iss}}$	Input Capacitance	$V_{\text{DS}} = 15 \text{ V}$ , $V_{\text{GS}} = 0 \text{ V}$	630		pF
$C_{\text{oss}}$	Output Capacitance	$f = 1.0 \text{ MHz}$	115		pF
$C_{\text{rss}}$	Reverse Transfer Capacitance		45		pF
$R_g$	Gate Resistance	$V_{\text{GS}} = 15 \text{ mV}$ $f = 1.0 \text{ MHz}$	2.4		$\Omega$

### Switching Characteristics (Note 2)

$t_{\text{d}(\text{on})}$	Turn–On Delay Time	$V_{\text{DD}} = 15 \text{ V}$ , $I_D = 1 \text{ A}$ ,		7	14	ns
$t_r$	Turn–On Rise Time	$V_{\text{GS}} = 10 \text{ V}$ , $R_{\text{GEN}} = 6 \Omega$		5	10	ns
$t_{\text{d}(\text{off})}$	Turn–Off Delay Time			21	34	ns
$t_f$	Turn–Off Fall Time			2.7	5.4	ns
$Q_g$	Total Gate Charge	$V_{\text{DS}} = 15 \text{ V}$ , $I_D = 2.6 \text{ A}$ ,		5.8	8.1	nC
$Q_{\text{gs}}$	Gate–Source Charge	$V_{\text{GS}} = 5 \text{ V}$		1.3	1.9	nC
$Q_{\text{gd}}$	Gate–Drain Charge			1.2	1.7	nC

### Drain–Source Diode Characteristics and Maximum Ratings

$I_S$	Maximum Continuous Drain–Source Diode Forward Current			0.7		A
$V_{\text{SD}}$	Drain–Source Diode Forward Voltage	$V_{\text{GS}} = 0 \text{ V}$ , $I_S = 0.7 \text{ A}$ (Note 2)		440	700	mV
$\text{trr}$	Diode Reverse Recovery Time	$I_F = 2.6 \text{ A}$ ,		10		ns
$\text{Qrr}$	Diode Reverse Recovery Charge	$d_i/d_t = 300 \text{ A}/\mu\text{s}$ (Note 2)		4		nC

#### Notes:

- $R_{\text{JJA}}$  is the sum of the junction-to-case and case-to-ambient thermal resistance where the case thermal reference is defined as the solder mounting surface of the drain pins.  $R_{\text{tJC}}$  is guaranteed by design while  $R_{\text{tCA}}$  is determined by the user's board design.



a)  $250^\circ\text{C}/\text{W}$  when mounted on a 0.02 in<sup>2</sup> pad of 2 oz. copper.

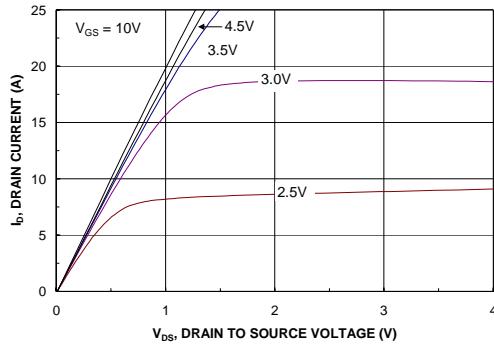


b)  $270^\circ\text{C}/\text{W}$  when mounted on a minimum pad.

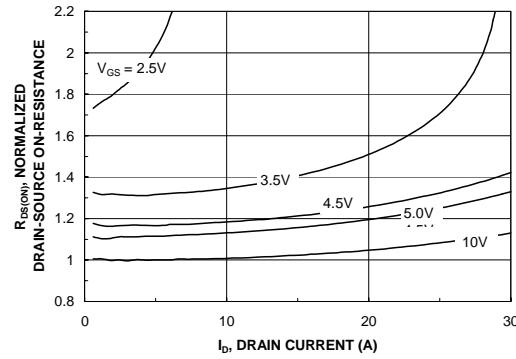
Scale 1 : 1 on letter size paper

- Pulse Test: Pulse Width  $\leq 300 \mu\text{s}$ , Duty Cycle  $\leq 2.0\%$

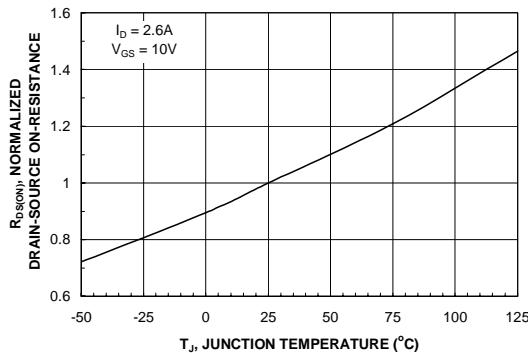
## Typical Characteristics



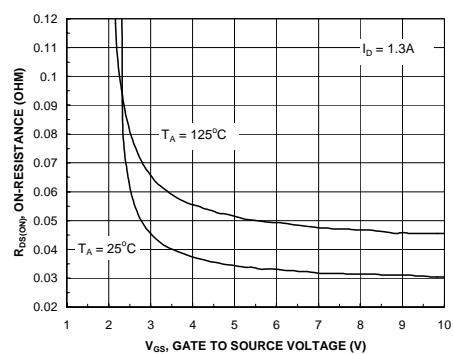
**Figure 1. On-Region Characteristics.**



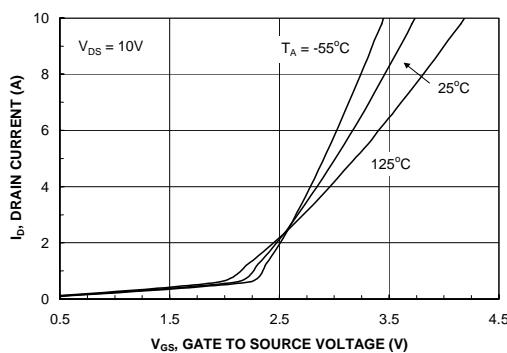
**Figure 2. On-Resistance Variation with Drain Current and Gate Voltage.**



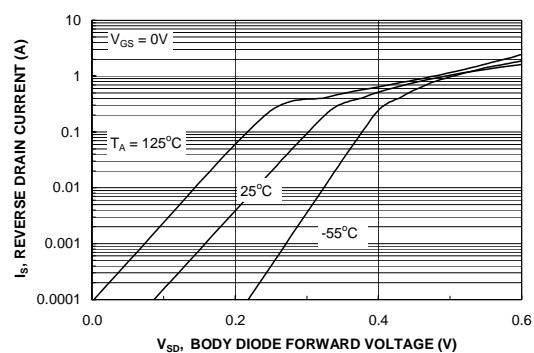
**Figure 3. On-Resistance Variation with Temperature.**



**Figure 4. On-Resistance Variation with Gate-to-Source Voltage.**

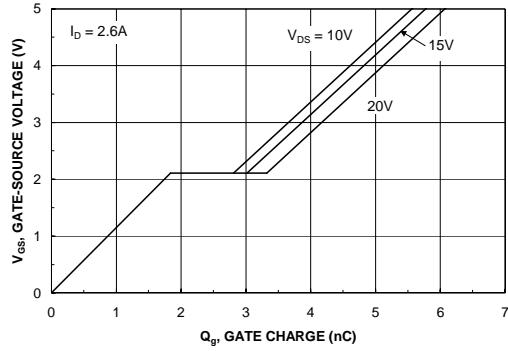


**Figure 5. Transfer Characteristics.**

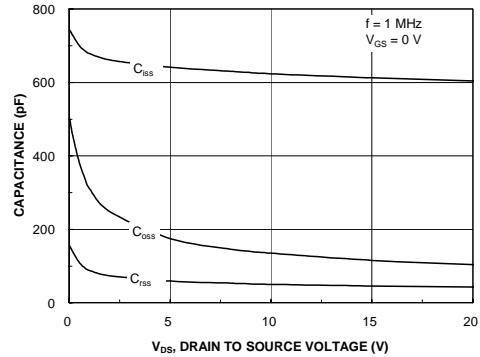


**Figure 6. Body Diode Forward Voltage Variation with Source Current and Temperature.**

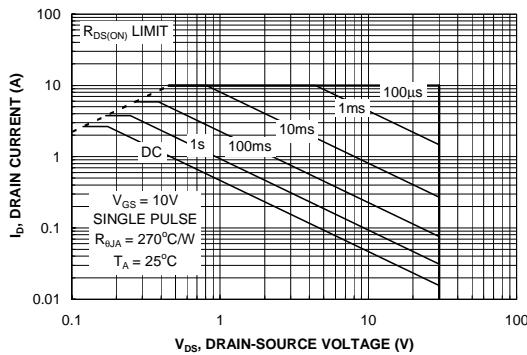
## Typical Characteristics



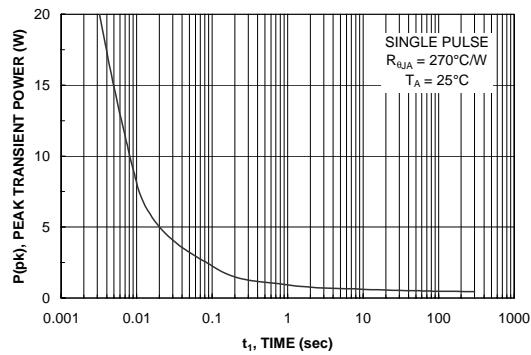
**Figure 7. Gate Charge Characteristics.**



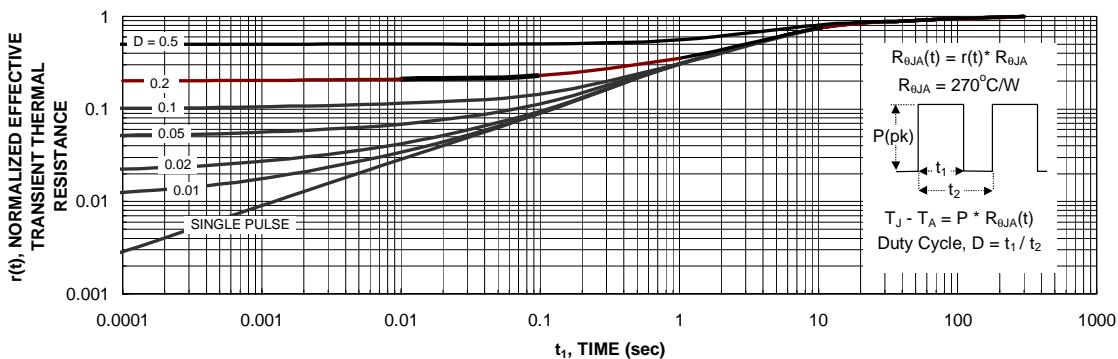
**Figure 8. Capacitance Characteristics.**



**Figure 9. Maximum Safe Operating Area.**



**Figure 10. Single Pulse Maximum Power Dissipation.**



**Figure 11. Transient Thermal Response Curve.**

Thermal characterization performed using the conditions described in Note 1b.  
Transient thermal response will change depending on the circuit board design.

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